EVERLIGHT

EVERLIGHT ELECTRONICS CO.,LTD.

Technical Data Sheet (Preliminary) Power Top View LED

67-31A/SAC-AW1X2B9Z5/2T

Features

- PLCC-3 package.
- High flux output.
- High current capability.
- White package.
- Optical indicator.
- Colorless clear window.
- Ideal for backlight and light pipe application.
- Inter reflector.
- Wide viewing angle.
- Suitable for automatic placement equipment.
- Suitable for reflow and wave solder processes.
- Available on tape and reel (8mm Tape).
- Ph-free
- The product itself will remain within RoHS compliant version.

Descriptions

The 67-31A series is available in soft orange, red and yellow. Due to the package design, the LED has wide viewing angle and optimized light coupling by inter reflector.

This feature makes the ideal for light pipe application. The low current requirement makes this device ideal for portable equipment or any other application where power is at a premium.

Applications

- Indicator and backlight for audio and video equipment.
- Indicator and backlight in office and family equipment.
- Flat backlight for LCD's, switches and symbols.
- Light pipe application.
- General use.

Device Selection Guide

Chip		Lens Color	
Material Emitted Color			
AlGaInP	Reddish Orange	Water Clear	



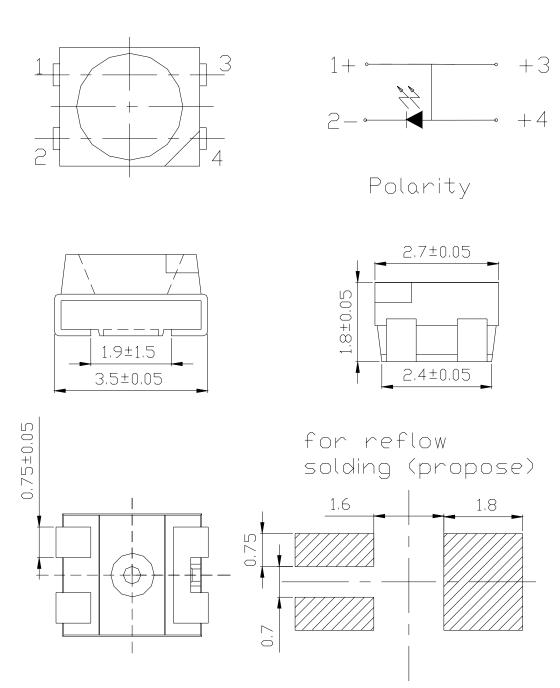
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Package Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm; Unit = mm

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Absolute Maximum Ratings ($T_A=25^{\circ}C$)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V_R	5	V
Forward Current	I_{F}	70	mA
Peak Forward Current (Duty 1/10 @1KHz)	Ifp	100	mA
Power Dissipation	Pd	120	mW
Electrostatic Discharge(HBM)	ESD	2000	V
Operating Temperature	T_{opr}	-40 ~ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	T_{stg}	-40 ~ +90	$^{\circ}\!\mathbb{C}$
Soldering Temperature	Tsol	Reflow Soldering: 260 Hand Soldering: 350	

Electronic Optical Characteristics:

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	I_{v}	1120		2850	mcd	I _F =50mA
Viewing Angle	$2 heta_{ ext{1/2}}$		120		deg	I _F =50mA
Peak Wavelength	λp		611		nm	I _F =50mA
Dominant Wavelength	λd	605.5		625.5	nm	I _F =50mA
Spectrum Radiation Bandwidth	Δλ		18		nm	I _F =50mA
Forward Voltage	$V_{\rm F}$	2.15		2.75	V	I _F =50mA
Reverse Current	I_R			10	μ A	$V_R=5V$

Notes:

- 1.Tolerance of Luminous Intensity ±10%
- 2. Tolerance of Dominant Wavelength ±1nm
- 3.Tolerance of Forward Voltage ±0.1V



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Bin Range Of Dominant Wavelength

Bin Code	Min.	Max.	Unit	Condition
E1	605.5	609.5		
E2	609.5	613.5		
E3	613.5	617.5	nm	I _F =50mA
E4	617.5	621.5		
E5	621.5	625.5		

Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition	
W1	1120	1420			
W2	1420	1800	,	IF=50mA	
X1	1800	2250	mcd		
X2	2250	2850			

Bin Range Of Forward Voltage

Group	Bin	Min	Max	Unit	Condition
В9	2	2.15	2.35	V	IF=50mA
	3	2.35	2.55		
	4	2.55	2.75		

Notes:

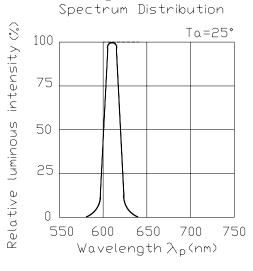
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- 2.Tolerance of Dominant Wavelength ±1nm
- 3.Tolerance of Forward Voltage ±0.1V

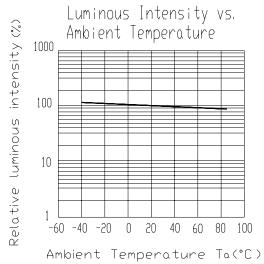
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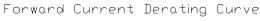
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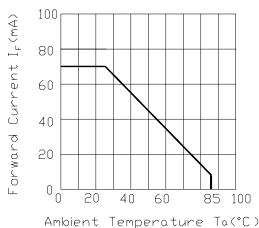
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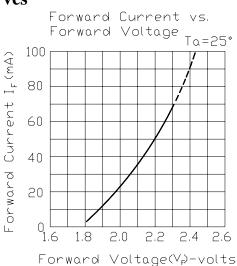
Typical Electro-Optical Characteristic Curves

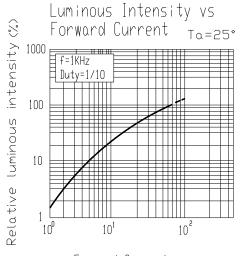


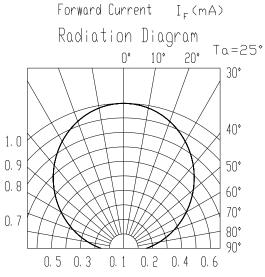












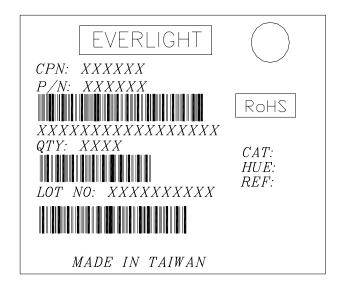
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Label explanation

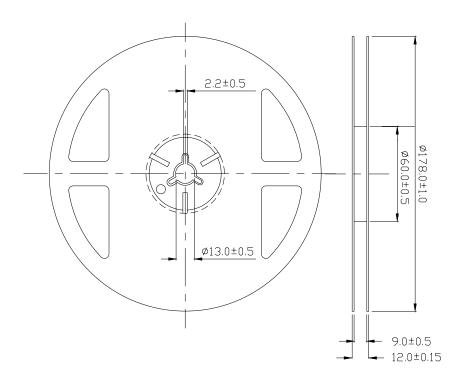
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions



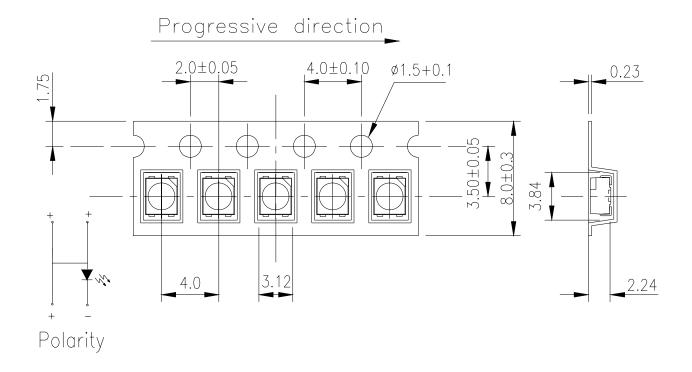
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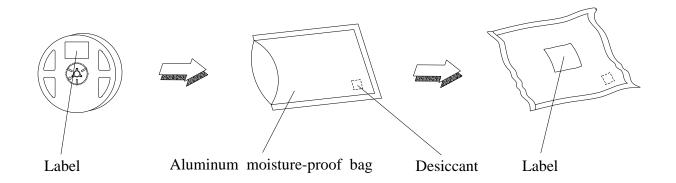
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Carrier Tape Dimensions; Loaded quantity per reel 2000 PCS/reel



Note: Tolerances Unless Dimension ± 0.1 mm Unit = mm

Moisture Resistant Packaging



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Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5 sec.	6 Min.	22 PCS	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min \int 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA} / 25^{\circ}\text{C}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/85%RH	1000 Hrs.	22 PCS.	0/1

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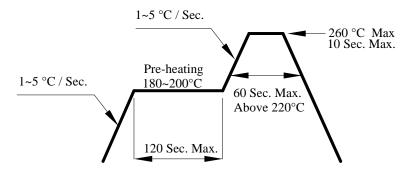
Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less.
 - 2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
 - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.
 - 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.
- 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

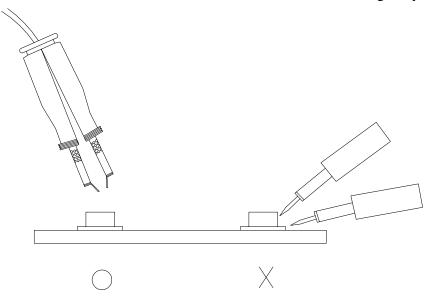
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5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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